Absolute Maximum Ratings (Ta = 25°C)

	(Characteristics	Symbol	Rating	Unit	
	Forward curre	ent	I _F	50	mA	
	Forward curre	ent derating (Ta ≥ 25 °C)	ΔI _F /°C	-0.5	mA/°C	
	Peak forward (100 μs pulse		l _{FP}	1	А	
LED	Reverse volta	ge	V _R	5	V	
	Diode power	dissipation	P _D	50	mW	
	Diode power	dissipation derating (Ta >25 °C)	ΔP _D /°C	-0.5	mW/°C	
	Junction temp	perature	Tj	125	°C	
	Off-state outp	ut terminal voltage	V _{OFF}	60	V	
	On-state current	A connection		400		
		B connection	I _{ON}	400	mA	
		C connection		800		
	Forward current derating (Ta ≥ 25 °C)	A connection		-4.0	mA/°C	
Detector		B connection	ΔI _{ON} /°C	-4.0		
		C connection		-8.0		
	Output power	dissipation	Po	256	mW	
	Output power	dissipation derating (Ta ≥ 25 °C)	ΔP _O / °C	-2.56	mW / °C	
	Junction temp	perature	Tj	125	°C	
Storage temperature			T _{stg}	-55 to 125	°C	
Operating temperature			T _{opr}	-40 to 85	°C	
Lead soldering temperature (10 s)			T _{sol}	260	°C	
	Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)			1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

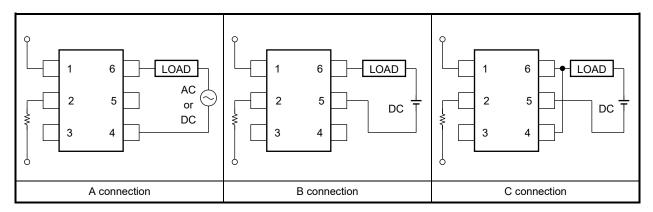
Note 1: LED pins are shorted together. Detector pins are also shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	48	٧
Forward current	lF	5	7.5	25	mA
On-state current	Ion	_	_	400	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections





Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse voltage	I _R	V _R = 5 V	_	_	10	μА
	Capacitance between terminals	CT	V _F = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	Voff = 60 V	_	_	1	μА
	Capacitance between terminals	Coff	V = 0 V, f = 1 MHz	_	130	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		lfT	I _{ON} = 400 mA	_	1.6	3	mA
Return LED current		IFC	IOFF = 100 μA	0.1	_	_	mA
	A connection		ION = 400 mA, IF= 5 mA	_	1	2	
On-state resistance	B connection		I _{ON} = 400 mA, I _F = 5 mA	_	0.5	1	Ω
	C connection		I _{ON} = 800 mA, I _F = 5 mA	_	0.25	_	

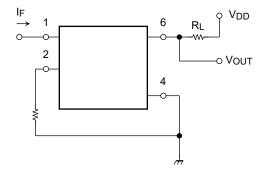
Isolation Characteristics (Ta = 25°C)

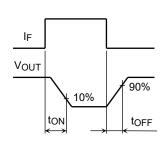
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	1500			Vrms

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note 2)	_	0.8	2	mo
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$	_	0.1	0.5	ms

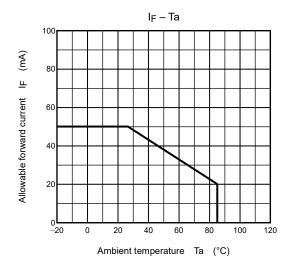
Note 2: Switching time test circuit

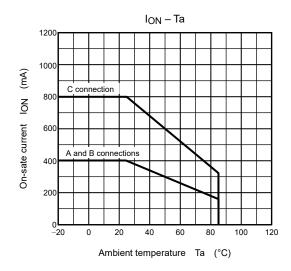


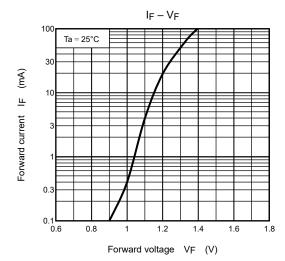


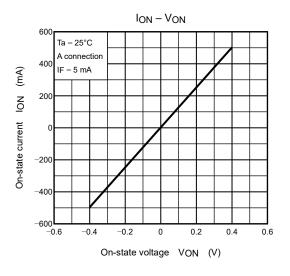
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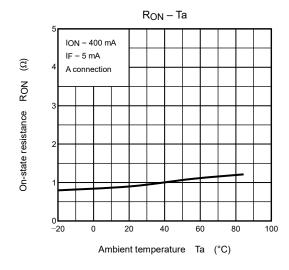
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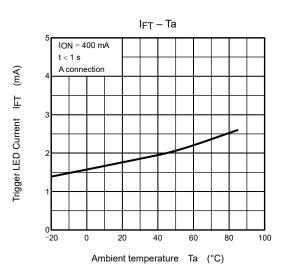




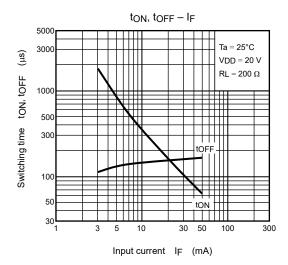


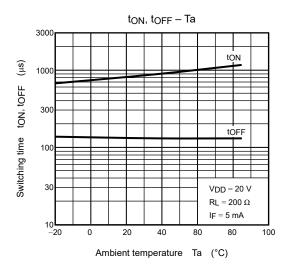


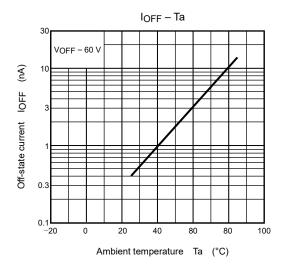




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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